

NOT RECOMMENDED FOR NEW DESIGNS
See HI1171

8-Bit, 35 MSPS, High Speed D/A Converter (TTL Input)

Features

- Resolution 8-Bit
- High Speed Operation 35MHz
(Maximum Conversion Speed)
- Non-Linearity Less Than $\pm 1/2$ LSB
- Low Glitch
- TTL Compatible Input
- Power Supply
 - Single..... +5V
 - Dual $\pm 5V$
- Low Power Consumption
 - +5V Single Power Supply (Typ)..... 200mW
 - $\pm 5V$ Dual Power Supply (Typ) 400mW
- Direct Replacement for the Sony CXA1106

Description

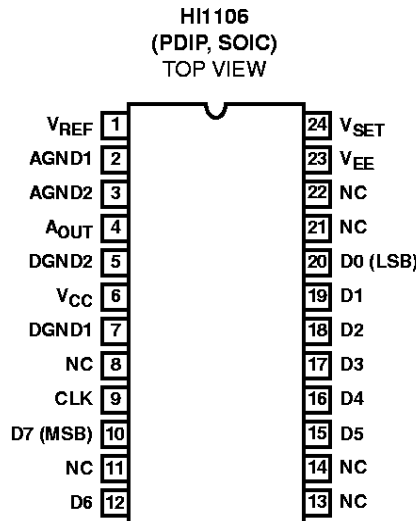
The HI1106 is an 8-bit, 35MHz, high-speed D/A converter IC. Summing type current for the upper 2 bits and ladder type resistance for the lower 6 bits, ensures a low power consumption of 200mW (single power supply).

This IC is suitable for digital TVs, graphic displays and other applications.

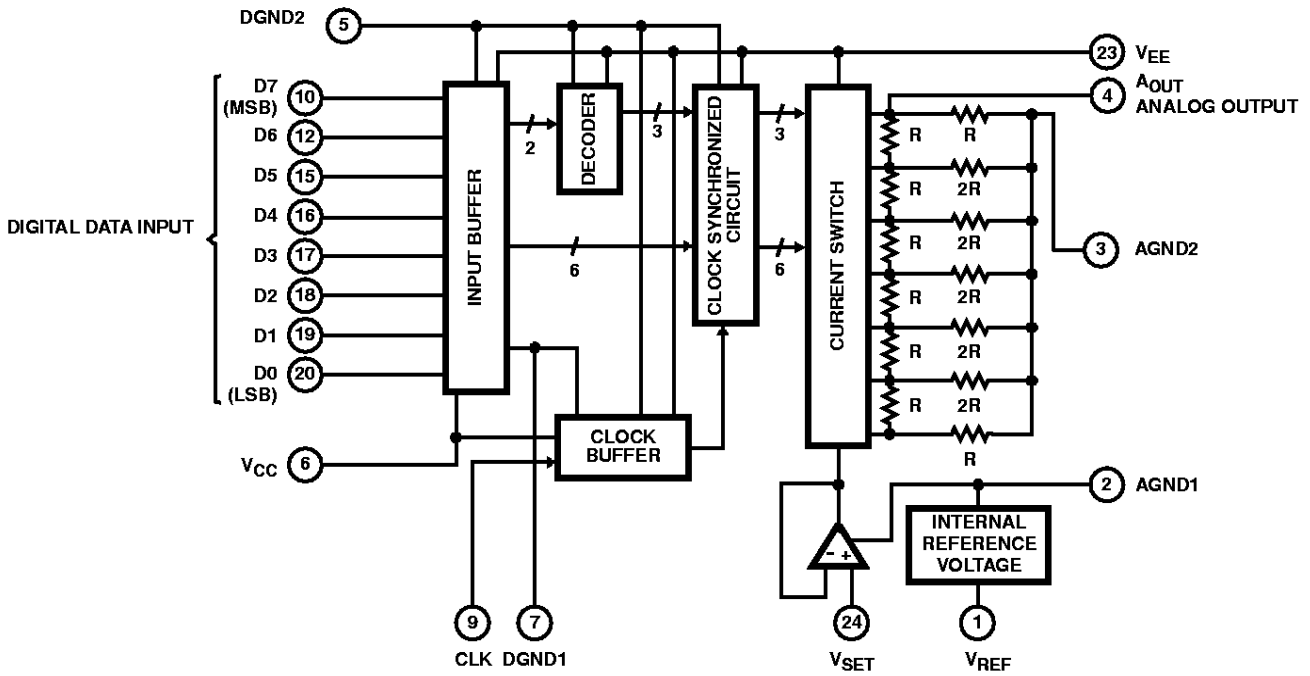
Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
HI1106JCB	-20 to 75	24 Ld SOIC	M24.2-S
HI1106JCP	-20 to 75	24 Ld PDIP	E24.4-S

Pinout



Functional Block Diagram



Pin Descriptions

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
1	V _{REF}		Internal Reference Voltage Output pin 1.2V (Typ). An external pull down resistance is necessary. For reference see Notes on Application 1.
2	AGND1		Set to Analog V _{CC} for signal power supply and to Analog GND for dual power supply. Connect to AGND2 and use.
3	AGND2		Connect to AGND1.
4	A _{OUT}		Analog Output pin.
5	DGND2		Set to Digital V _{CC} for signal power supply and to Digital GND for dual power supply.
6	V _{CC}		Digital V _{CC} .
7	DGND1		Digital GND.

Pin Descriptions (Continued)

PIN NO.	SYMBOL	EQUIVALENT CIRCUIT	DESCRIPTION
8	NC		No Connect.
9	CLK		Clock Input pin.
10, 12, 15 - 20	D7, D6, D5 - D0		Digital Input pin. D1 to MSB, D8 to LSB
11, 13, 14	NC		No Connect
21, 22	NC		Connect to AGND or V _{EE} .
23	V _{EE}		Set to Analog GND for single power supply and to V _{EE} for dual power supply.
24	V _{SET}		Bias Input pin. Normally set V _{SET} - V _{EE} to 0.84V. For reference see Notes on Application 1.

NOTE: See the Application Circuit for reference.

Absolute Maximum Ratings $T_A = 25^{\circ}\text{C}$

Supply Voltage	
V_{CC} - DGND1	0V to 6V
V_{EE} - AGND1, AGND2	-6V to 0V
DGND2 - DGND1	0V to 6V
Digital Input Voltage	
V_I	DGND1 - 0.3V to $V_{CC} + 0.3\text{V}$
V_{CLK}	DGND1 - 0.3V to $V_{CC} + 0.3\text{V}$
Input Voltage (V_{SET} Pin), V_{SET}	$V_{EE} - 0.3\text{V}$ to $V_{EE} + 2.7\text{V}$
Output Current (V_{REF} Pin), I_{REF}	-5mA to 0mA

Recommended Operating Conditions

SINGLE POWER SUPPLY	MIN	TYP	MAX
Supply Voltage			
V_{CC} , DGND2, AGND1, AGND2	4.75V	5V	5.25V
DGND2 - AGND1, DGND2 - AGND2	-0.2V	0V	0.2V
AGND1 - AGND2	-0.1V	0V	0.1V
Digital Input Voltage			
H Level, V_{IH} , V_{CLKH}	2.0V	-	V_{CC}
L Level, V_{IL} , V_{CLKL}	DGND1	-	1V
V_{SET} Input Voltage, V_{SET}	0.70V	0.84V	1V
V_{REF} Pin Current, I_{REF}	-3.0mA	-	-0.4mA
Clock Pulse Width (Note 1)			
t_{PW1}	10ns	-	-
t_{PW0}	10ns	-	-
Temperature Range, T_{OPR}	-20°C		75°C

Thermal Information

Thermal Resistance (Typical, Note 2)	θ_{JA} (°C/W)
PDIP Package	90
SOIC Package	90
Maximum Power Dissipation, P_D	1.27W
Maximum Junction Temperature (Plastic Package)	150°C
Maximum Storage Temperature Range, T_{STG}	-55°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC - Lead Tips Only)	

DUAL POWER SUPPLY	MIN	TYP	MAX
Supply Voltage			
V_{CC}	4.75V	5V	5.25V
V_{EE}	-5.5V	5V	-4.75V
DGND2 - AGND1, DGND2 - AGND2	-0.2V	0V	-0.2V
AGND1 - AGND2	-0.1V	0V	0.1V
Digital Input Voltage			
H Level, V_{IH} , V_{CLKH}	2.0V	-	V_{CC}
L Level, V_{IL} , V_{CLKL}	DGND1	-	1V
V_{SET} Input Voltage, V_{SET}	-4.30V	-4.16V	-4.00V
V_{REF} Pin Current, I_{REF}	-3mA	-	-0.4mA
Clock Pulse Width			
t_{PW1}	10ns	-	-
t_{PW0}	10ns	-	-

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- See Figure 6 in the Timing Diagram.
- θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $T_A = 25^{\circ}\text{C}$, $V_{CC} = \text{DGND2} = \text{AGND1} = \text{AGND2} = 5\text{V}$, $\text{DGND1} = V_{EE} = 0\text{V}$, $V_{SET} = 0.84\text{V}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SINGLE POWER SUPPLY					
Resolution, n		-	8	-	Bit
Maximum Conversion Speed, f_{MAX}	$R_L > 10\text{k}\Omega$, $C_L < 20\text{pF}$	35	-	-	MHz
Linearity Error, EL	$R_L > 10\text{k}\Omega$	-0.5	-	0.5	LSB
Differential Linearity Error, ED		-0.5	-	0.5	LSB
Full Scale Output Voltage, V_{FS}	$R_L > 10\text{k}\Omega$	0.9	1.0	1.1	V
Offset Voltage (Note 2), V_{OS}	$R_L > 10\text{k}\Omega$	0	4	10	mV
Output Resistance, R_O		290	350	410	Ω
Power Supply Current, I_{CC}	$R_L > 10\text{k}\Omega$, $I_{REF} = -400\mu\text{A}$	32	40	48	mA
Digital Input Current					
H Level, I_{IH}		0	-	5	μA
L Level, I_{IL}		-400	-	0	μA
V_{SET} Input Current, I_{SET}		-3	-	0	μA
Internal Reference Output Voltage, V_{REF}	$I_{REF} = -400\mu\text{A}$	1.17	1.25	1.33	V
Accuracy Output Voltage Range, V_{OC}	$R_L > 10\text{k}\Omega$	0.5	1.0	1.50	V
Set-Up Time, t_S		10	-	-	ns
Hold Time, t_H		2	-	-	ns
Propagation Delay Time, t_{PD}	$R_L > 10\text{k}\Omega$	-	11	-	ns
Glitch Energy, GE	$R_L > 10\text{k}\Omega$, $f_{CLK} = 1\text{MHz}$, Digital Lamp Output	-	30	-	pV/s

NOTE:

- $V_{OS} = \text{AGND2} - V_{255}$ (V_{255} is the output voltage when full input is at high level).

HI1106

Electrical Specifications $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$, $\text{DGND1} = \text{DGND2} = \text{AGND1} = \text{AGND2} = 0\text{V}$, $V_{EE} = -5\text{V}$, $V_{SET} - V_{EE} = 0.84\text{V}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DUAL POWER SUPPLY					
Resolution, n		-	8	-	Bit
Maximum Conversion Speed, f_{MAX}	$R_L > 10\text{k}\Omega$, $C_L < 20\text{pF}$	35	-	-	MHz
Linearity Error, EL	$R_L > 10\text{k}\Omega$	-0.5	-	0.5	LSB
Differential Linearity Error, DNL		-0.5	-	0.5	LSB
Full Scale Output Voltage, V_{FS}	$R_L > 10\text{k}\Omega$	0.9	1.0	1.1	V
Offset Voltage, V_{OS}	$R_L > 10\text{k}\Omega$	0	4	10	mV
Output Resistance, R_O		290	350	410	Ω
Power Supply Current	$R_L > 10\text{k}\Omega$, $I_{REF} = -400\mu\text{A}$				
I_{CC}		24	30	36	mA
I_{EE}		40	50	60	mA
Digital Input Current					
H Level, I_{IH}		0	-	5	μA
L Level, I_{IL}		-400	-	0	μA
V_{SET} Input Current, I_{SET}		-3	-	0	μA
Internal Reference Output Voltage, V_{REF}	$I_{REF} = -400\mu\text{A}$	-3.83	-3.75	-3.67	V
Accuracy Output Voltage Range, V_{OC}	$R_L > 10\text{k}\Omega$	0.5	1.0	1.50	V
Set-Up Time, t_S		10	-	-	ns
Hold Time, t_H		2	-	-	ns
Propagation Delay Time, t_{PD}	$R_L > 10\text{k}\Omega$	-	11	-	ns
Glitch Energy, GE	$R_L > 10\text{k}\Omega$, $f_{CLK} = 1\text{MHz}$ Digital Lamp Output	-	30	-	pV/s

INPUT/OUTPUT CODE TABLE
(When Output Full Scale Voltage at 1.00V)

INPUT CODE								OUTPUT VOLTAGE (SINGLE SUPPLY)	OUTPUT VOLTAGE (DUAL SUPPLY)
MSB							LSB		
1	1	1	1	1	1	1	1	V_{CC}	-0V
1	0	0	0	0	0	0	0	$V_{CC} - 0.5\text{V}$	-0.5V
0	0	0	0	0	0	0	0	$V_{CC} - 1\text{V}$	-1V

Test Circuits

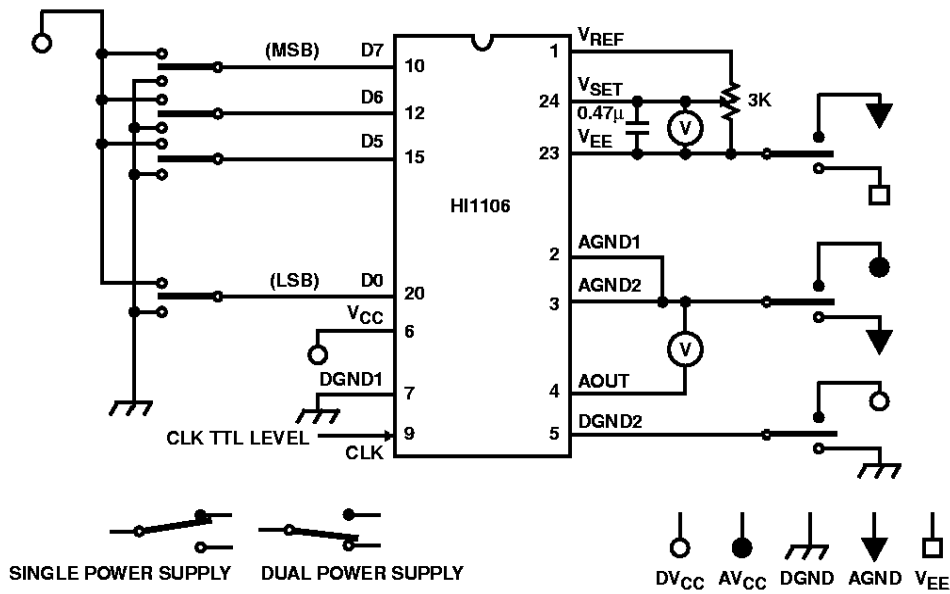


FIGURE 1. DC CHARACTERISTICS

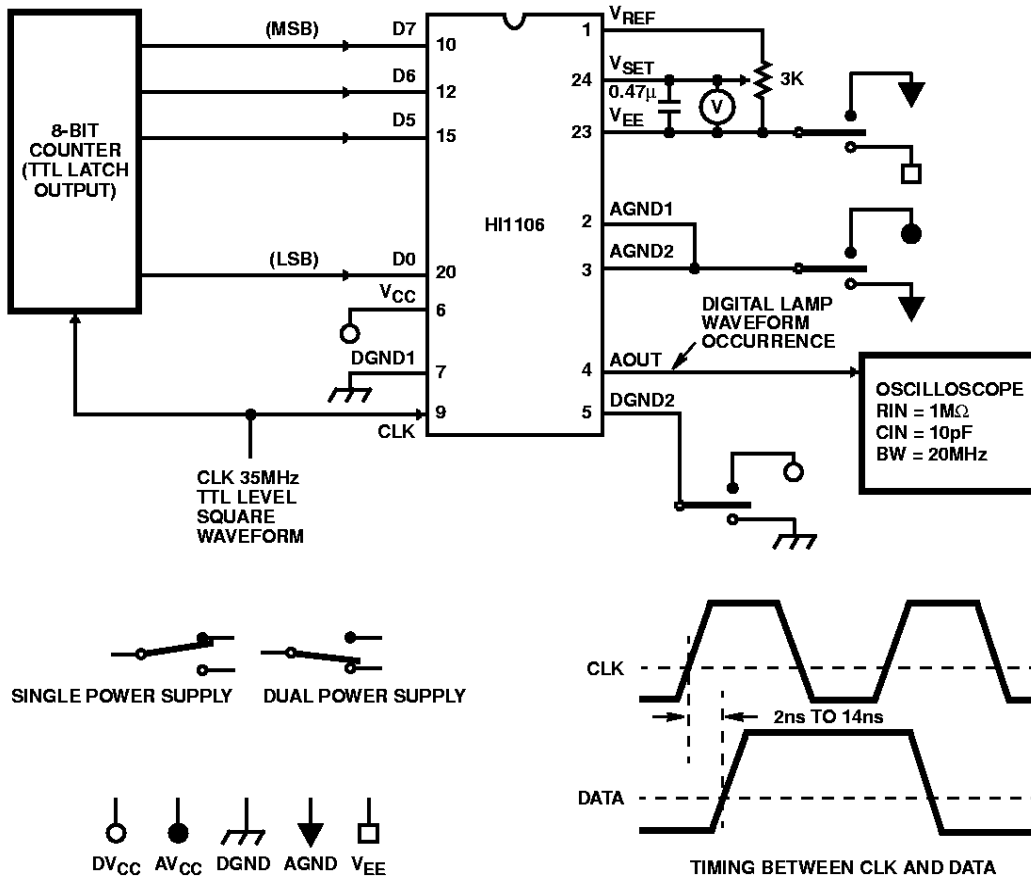


FIGURE 2. MAXIMUM CONVERSION SPEED

Test Circuits (Continued)

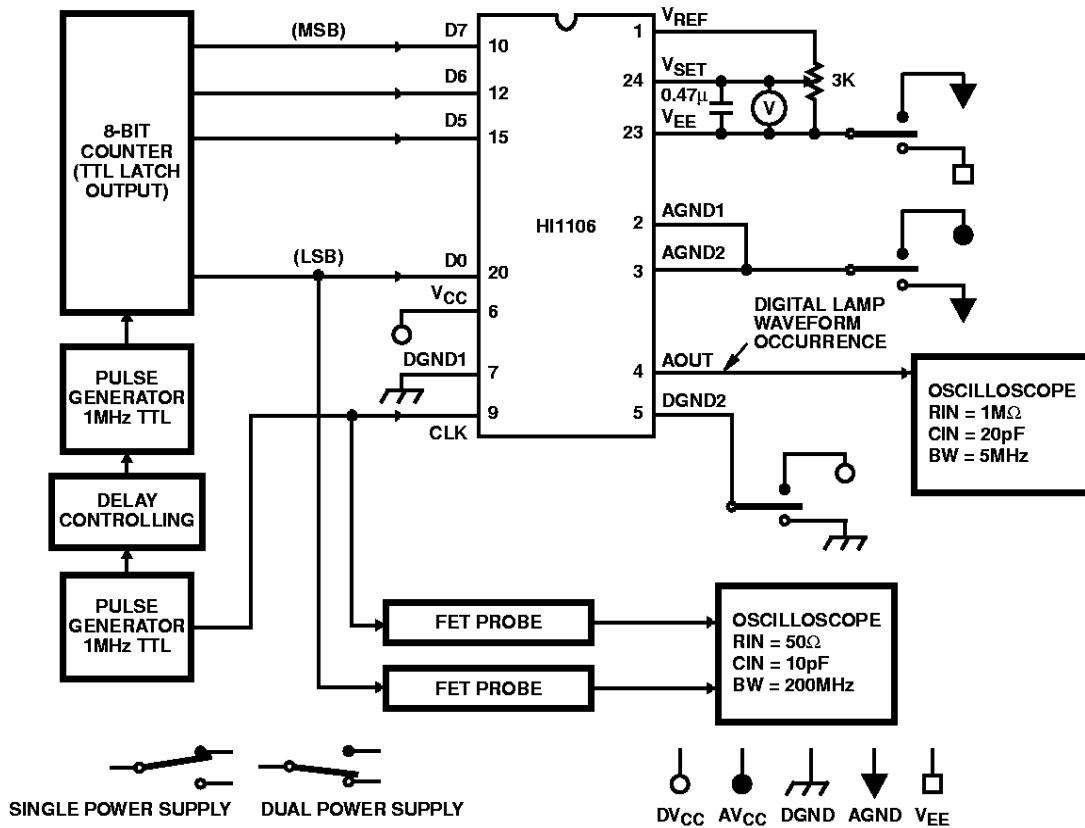


FIGURE 3. SET-UP TIME AND HOLD TIME

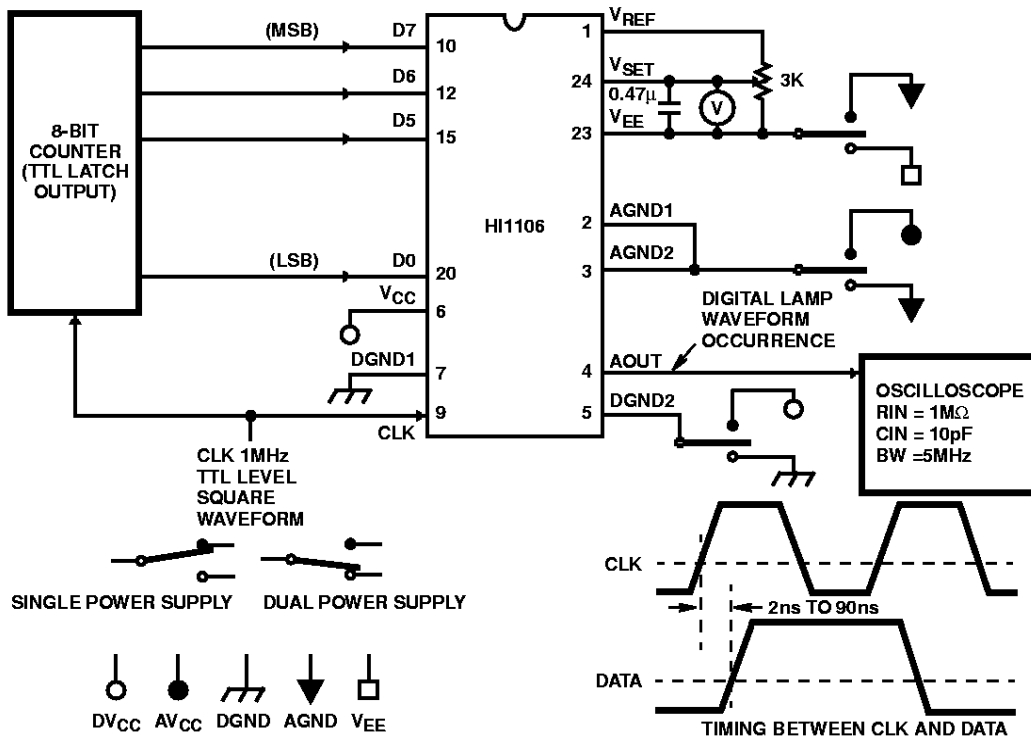


FIGURE 4. GLITCH AREA